

IN THE UNITED STATES
PATENT AND TRADEMARK OFFICE

PATENT APPLICATION

Applicant(s): Hey, et al.

Case: 4662/ISM/COPPER/DV

Serial No.: ~~Not yet assigned~~
09/916365
1741

Filed: Herewith

Group Art Unit: ~~Not yet assigned~~

Title: DYNAMIC PULSE PLATING FOR HIGH ASPECT RATIO
FEATURES

ASSISTANT COMMISSIONER OF PATENTS
Washington, DC 20231

S I R:

Disclosure Statement under 37 CFR 1.56 and 1.98

Pursuant to 37 C.F.R. 1.56, the documents (copies enclosed) listed on form PTO-1449, submitted herewith, are disclosed. Under rule 37 C.F.R. 1.98(a), the applicants submit that no specific comments are necessary for any of the cited English language publications having an enclosed English language translation or abstract.

June 26, 2001
Date

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11-27-01

J1046 U.S. PTO

09/916365



U.S. Department of Commerce, Patent and Trademark Office				Docket No.		Serial No.		
(PTO Form 1449 modified)				4662/ISM/COPPER/DV		Unknown		
LIST OF PATENTS AND PUBLICATIONS CITED BY APPLICANT				Applicant				
(Use several sheets if necessary)				Hey et al.				
				Filing Date		Group		
				Herewith		Unknown		
U.S. Patent Documents								
Examiner Initial		Document Number	Issue Date	Name	Class	Subclass	Filing Date If Appropriate	
	AA	6,235,625 B1	5/22/2001	Lou	438	618	6/18/1999	
	AB	6,004,188	12/21/1999	Roy	451	41	9/20/1998	
	AC							
	AD							
	AE							
	AF							
	AG							
	AH							
	AI							
Foreign Patent Documents								
							Translation	
		Document Number	Date	Country	Class	Subclass	Yes	No
	AL							
	AM							
	AN							
	AO							
	AP							
OTHER ART (Including Author, Title, Date, Pertinent Pages, Etc.)								
	AQ							
	AR							
	AS							
Examiner			Date Considered					
<p>*EXAMINER: Initial if reference considered, whether or not citation is in conformance with MPEP 609; Draw line through citation if not in conformance and not considered. Include copy of this form with your communication to applicant.</p>								

